

FACED PANEL

MATRICE LR55

SUPPORT: Chipboard, MDF
FORMAT: 5600 x 2070 mm
THICKNESS: from 8 to 38 mm
TEXTURE ORIENTATION: Vertical
BACK TEXTURE: Matrice
NOMINAL OVERTHICKNESS: +0.3 mm

LAMINATE

MATRICE LR55

TYPE: HPL
FORMAT: 3050 x 1300 mm
THICKNESS: 0.6 mm, 0.8 mm
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TYPE: CPL
FORMAT: 1300 mm
THICKNESS: from 0.2 to 0.4 mm
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TYPE: HyperFlex
FORMAT: 1300 mm
THICKNESS: 0.1 mm, 0.15 mm, 0.2 mm

EDGE

MATRICE LR55

TYPE: ABS
HEIGHT: from 15 to 330 mm
THICKNESS: from 0.5 to 2.0 mm

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